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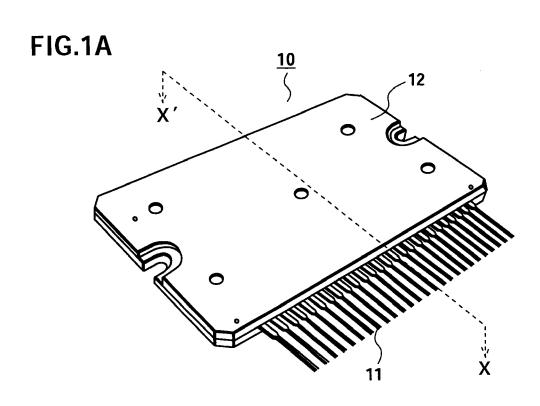
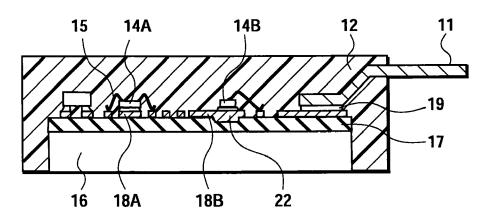


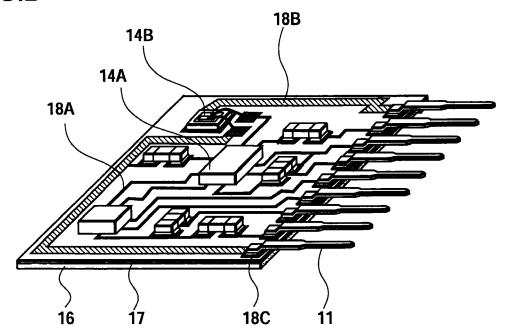
FIG.1B



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FIG.2



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FIG.3A

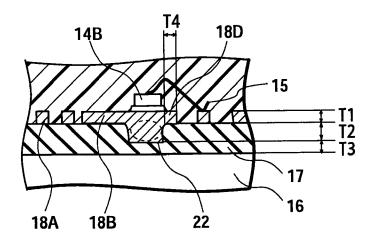


FIG.3B

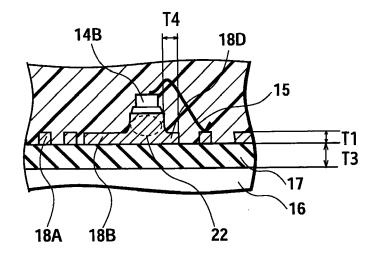
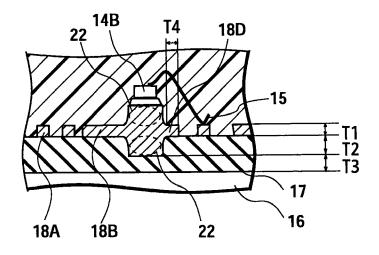
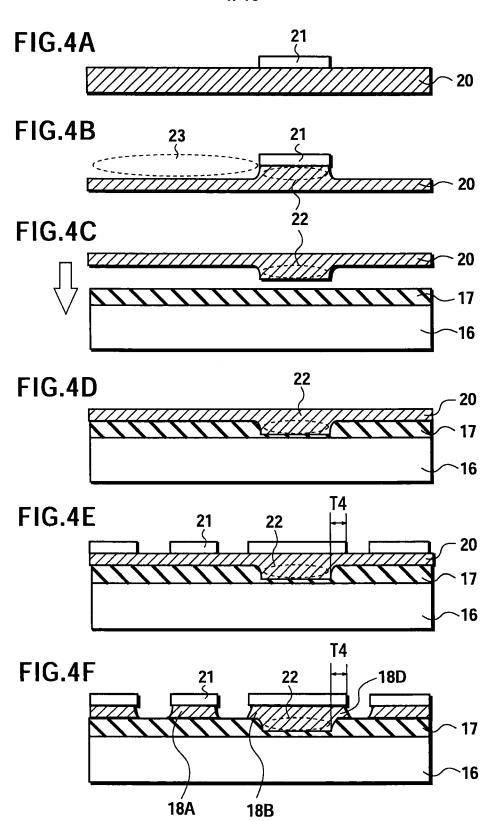


FIG.3C



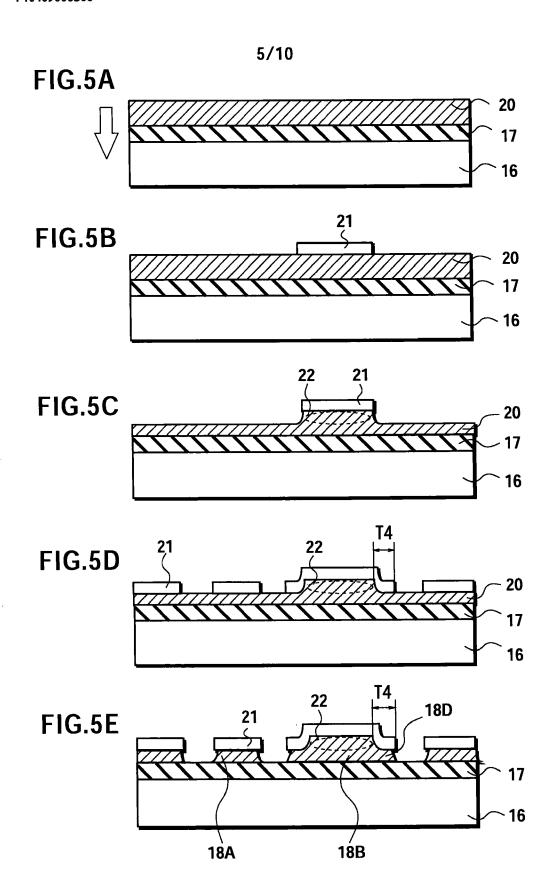
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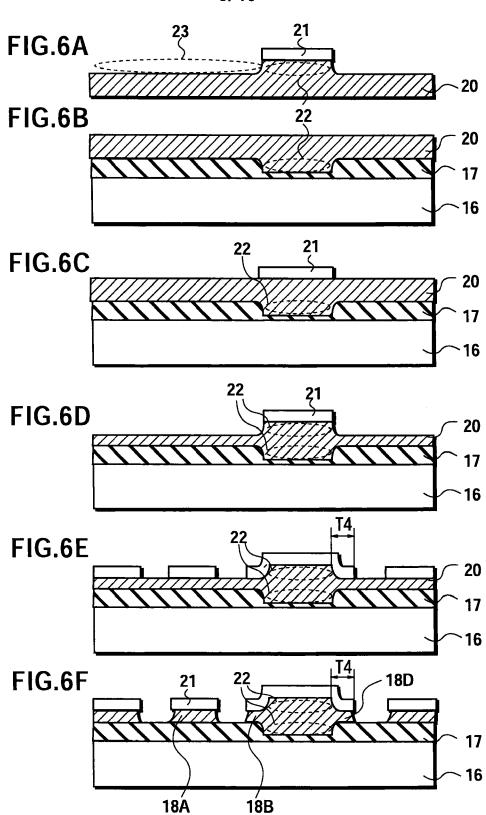
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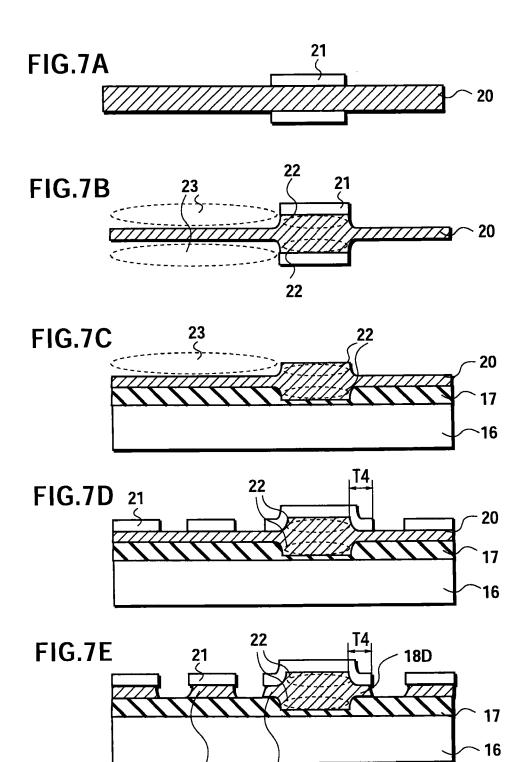
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18A

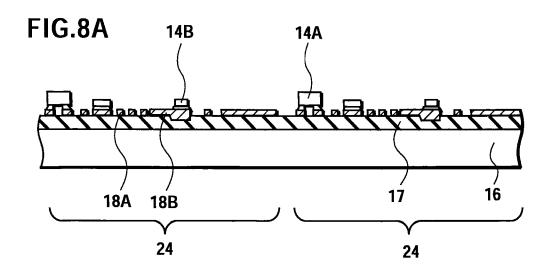
18B

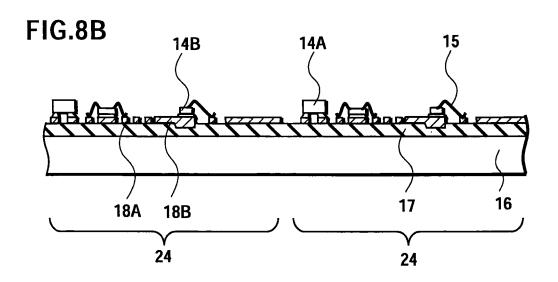
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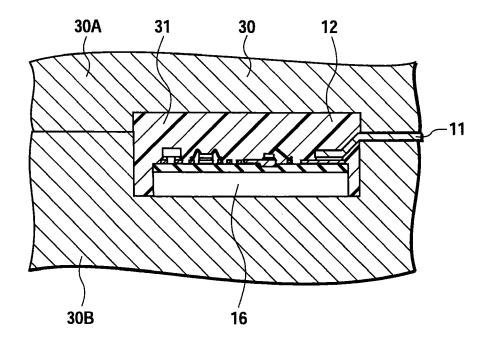




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FIG.9



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